

## Information note

N° 044/21

## Dear customer,

With this Infineon Technologies AG information note, we would like to inform you about the following

Second source substrate supplier and change of the pre-plating of the PrimePACK™ IGBT5/.XT substrates



On 16 April 2020, Infineon acquired Cypress.

We are now in the process of merging and consolidating our tools and processes for PCN, Information Notes, Errata and Product Discontinuance.

For further details, please visit our website:

https://www.infineon.com/cms/en/about-infineon/company/cypress-acquisition/

Infineon Technologies AG

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▶ Products affected

Please refer to affected product list 1\_cip04421



Detailed change information

Subject •

- Second source substrate supplier
- Harmonization of the PrimePACK<sup>™</sup> substrates

Reason •

- Ensure security of supply by release of second source substrate supplier for PrimePACK™ .XT
- Module production process harmonization of PrimePACK™ substrates

ion	Old		New	
	•	Single source substrate supplier	•	Second sourcing of substrate supplier
	•	Partial pre-plating on the substrate at the chip positions	•	None pre-plating on the substrate

- ► Product identification
- Date code
- ► Impact of change
- Beside the above-mentioned changes, the other specifications of the mentioned modules, like electrical- and mechanical module parameters, remain unchanged according to JEDEC Standard JESD46-C: form, fit, function and reliability.
- Attachments
- 1\_cip04421.pdf affected product list
- Intended start of delivery

2021-09-01

If you have any questions, please do not hesitate to contact your local sales office.